About Organisation

Name of Company: **Oualcomm**

Date of Establishment: 1985-01-07

Number of Employees: 47000

Social Media Page Link: www.qualcomm.com

Website: www.qualcomm.com

MNC (Foreign Origin) Type of Organization:

Location of Head office: USA

Nature of Business: Core Engineering & Technology

Internship Profile

Job Title: Interim Engineering Intern- HW

Job Description: Job Area :Engineering

> Job Location: Bangalore / Hyderabad / Chennai / Noida We know our employees' ideas change the world. For

more than three decades, we've been a

global leader in mobile technology, continually pushing

the boundaries of what's possible.

Working with customers across industries - from

automotive to health care, from smart cities

to robotics- we continue to accelerate innovation and

unlock new possibilities in a time where

everything is connected. By joining the Qualcomm family,

you too can bring the future forward

faster.

Qualcomm is looking for an energetic, creative and self-

driven engineer to work in Modem,

Multimedia, Connectivity, Computer Vision and Image

Processing, software implementation

and hardware acceleration. The work will directly

influence the various subsystems within the

SoC. The ideal candidate would have very strong problem

solving and analytical skills combined

with creativity and a passion for innovation. They would

be able to carry forward that new idea,

concept, and/or application that will propel systems to

new levels of effectiveness and efficiency. At Qualcomm you will perform detailed

technical analysis, translate ideas into

models, SW and/or HW and work closely with other teams

to help deliver real products.

At Qualcomm, the sky's the limit. College Graduates play

important roles everywhere in the

company. Many of our 27,000+ employees join us right out of school because we're working on

the cutting edge in wireless. Complex wireless devices are only as powerful as the software that

runs them. As a software engineer, you will develop, implement and maintain multimedia,

gaming and application software for the world's leadingedge mobile devices.

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global leader in mobile technology, continually pushing the boundaries of what's possible.

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to robotics— we continue to accelerate innovation and unlock new possibilities in a time where

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- SOC & Hard Macro Physical Design
- SOC Validation & Debug
- RF & Analog Layout
- RF/Analog/Mixed Signal/Power IC Design
- Low Power Design
- Board and FPGA Design\
- Digital ASIC Design
- Design/SOC Verification
- CAD Solution Engineer
- Design for Test (DFT)
- CPU Desig

Must have educational background in one or more of the following areas:

- Verifying SoC with embedded RISC/DSP processors, communications/ networking ASICs.
- Verilog or VHDL, C/C++, Tcl/Perl/shell-scripting. RTL design experience and/or strong OO programming knowledge
- Knowledge of wireless/wired communications and protocols or graphics/video multi@media is a plus.
- Knowledge in PLL, LNA, OpAmp, CMOS, ADC/DAC, Cadence, SpectreRF, or Layout is required in RF/Analog/Mixed Signal IC Design.
- Excellent analytical and problem solving skills.
- Ability to collaborate and work in teams.
- Good verbal and written communication skill Educational Background:

Masters, Bachelors: Electrical Engineering, VLSI, Embedded and VLSI, ECE

Minimum No. of Hires: 2

Expected No. of Hires: 5

Location(s)/Place of Posting/Online: Bangalore, HYD, Noida

Skillset: VLSI, Electrical eng

Minimum CGPA: 7.5

Students with backlog eligible: No

Selection Process

Resume Shortlist: Yes

Mode of Selection: Hybrid

Resume shortlisting before test?: No

Test: Yes

Mode of Test: Online

Test duration (minutes): 90

Aptitude/Psycometric: Yes

Technical: Yes

Group Discussion: No

Personal Interview: Yes

Technical Round: Yes

HR Round: Yes

Medical Test: No

Eligible Academic Programs

Diversity No

Recruiting:

Eligible

Graduating in 2026 (Pre-Final Year Students) - B.Tech / Dual / Master's

Years:

Eligible B.Tech in Electrical Engineering, B.Tech in Electrical Engineering (Power and

Departments: Automation)

Stipend Details

Stipend (per month) (In INR Per 45,000 INR Per Month

Month):

Accommodation: yes

Any other perks/ benefits/ Medical insurance

components:

Provision of PPO based on Yes

performance?

Tentative CTC for PPO select: 29LPA, 35LPA INR Per Annum

Others

Medical Requirements: No

Other Requirements: No